

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class* Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg

Form Type* Distribute Infomation

| | Infoliation | | | | | | |
|-----------------------------|------------------------|--------------------------|-----------------------------------|--|--|--|--|
| Supplier Information | | | | | | | |
| Company Name * | Company Unique ID | Unique ID Authority | Response Date* | | | | |
| Fairchild Semiconductor | 00-489-5751 | Dun & Bradstreet | Sat, Feb 22, 2014 02:56 AM | | | | |
| Contact Name * | Title - Contact | Phone - Contact * | Email - Contact * | | | | |
| David Lancaster | Product Ecology | 801-562-7455 | david.lancaster@fairchildsemi.com | | | | |
| Authorized Representative * | Title - Representative | Phone - Representative * | Email - Representative * | | | | |
| David Lancaster | Product Ecology | 801-562-7455 | david.lancaster@fairchildsemi.com | | | | |
| | | | | | | | |

| Requester Item Number | Mfr Ite | m Number | Mfr Item Name | | Effective Date | Version | I | Manufacturing Site | Weight* | UOM | Unit Type |
|-----------------------------------|------------|----------------------|---------------|-------------------------------|----------------|------------------------------|-----------------|--------------------|----------|-----|-----------|
| FOD3180SD | FOD | 3180SD | SMDIPW-8 | | | | INTERNAL PENANG | | 0.497659 | g | Each |
| Manufacturing Process Information | | | | | | | | | | | |
| Terminal Finish | Base Alloy | J-STD-020 MSL Rating | | Peak Process Body Temperature | | Max Time at Peak Temperature | | No Reflow cycles | | | |
| Matte Tin (Sn) | CU Alloy | 1 | | | 260 C | | 30 seconds | | | 3 | |

* Required Field

| RoHS Material | Composition Declaration | Declaration Type * Custom | | | | | |
|--|---|------------------------------|--|--|--|--|--|
| RoHS Directive 2011/65/EU | RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium | | | | | | |
| restriction of the | Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the cou ise of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this docun irchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide. | | | | | | |
| ensure our production independently vertices | The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties. | | | | | | |
| Safety Data Sheet miniscule quantit | the content disclosed herewith is approximate and is based on various methods including, engineering calculations, is, analytical measurements. Fairchild may update this document without notification. This statement may not include of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed contain alternate substances of similar composition. | le information regarding the | | | | | |
| RoHS Declaration | * 1 - Item(s) does not contain RoHS restricted substances per the definition above Sup | plier Acceptance * Accepted | | | | | |
| 1 · · · · · · · · · · · · · · · · · · · | ne declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exer ponse in the RoHS Declaration above and choose all applicable exemptions. | nptions, then select the | | | | | |
| Exemption None | List Version EL-2011/534/EU | | | | | | |
| Declaration Sign | ature | | | | | | |

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SMDIPW-8

| Component | Material | Weight (mg) | Jig Level | Substance Category | Substance | Weight (mg) | CAS | PPM |
|---------------|----------------------------------|----------------|--------------|--|----------------------------|----------------|------------|--------|
| Chip | Other inorganic materials | 4.010 | Supplier | | Gallium Arsenide | 0.281 | 1303-00-0 | 565 |
| | | | Supplier | | Silicon | 3.730 | 7440-21-3 | 7495 |
| Coupling Gel | Other Organic Materials | 0.450 | Supplier | | Dimethyl Cyclosiloxanes | 0.076 | 69430-24-6 | 152 |
| | | | Supplier | | Methyltrimethoxysilane | 0.156 | 1185-55-3 | 313 |
| | | | Supplier | | Xylene | 0.218 | 1330-20-7 | 438 |
| Die Attach | Other Organic Materials | 0.250 | Supplier | | Acrylic Resin | 0.063 | 54208-63-8 | 126 |
| | | | Supplier | | Silver | 0.188 | 7440-22-4 | 378 |
| Encapsulation | Thermoplastics | 375.000 | В | Antimony/Antimony Compounds | Antimony Trioxide | 11.300 | 1309-64-4 | 22706 |
| | | | В | Brominated Flame Retardants (other than PBCs or PBDEs) | Bromine Resin | 15.000 | 6386-73-8 | 30141 |
| | | | Supplier | | Epoxy Resin | 86.300 | 29690-82-2 | 173412 |
| | | | Supplier | | Silica, vitreous | 263.000 | 60676-86-0 | 528474 |
| Lead Frame | Copper & its alloys | 113.000 | Supplier | | Copper | 109.000 | 7440-50-8 | 219026 |
| | | | Supplier | | Iron | 2.590 | 7439-89-6 | 5204 |
| | | | Supplier | | Phosphorus | 0.034 | 7723-14-0 | 68 |
| | | | Supplier | | Silver | 0.709 | 7440-22-4 | 1425 |
| | | | Supplier | | Zinc | 0.135 | 7440-66-6 | 271 |
| Plating | Other Nonferrous metals & alloys | 2.880 | Supplier | | Tin | 2.880 | 7440-31-5 | 5787 |
| Wire Bond | Precious metals | 2.000 | Supplier | | Gold | 2.000 | 7440-57-5 | 4019 |